

Softtherm[®]: Silicone Free U 200 and U 281



Flexible ceramic thermal-conducting and insulating films. Softtherm U 200 and U 281 are particularly suited for silicone-sensitive applications and as an alternative to silicone-based Softtherm films.

These silicone-free Softtherm films have high electrical insulation and very good thermal conductivity.

Optional available with adhesive coating!

APPLICATIONS

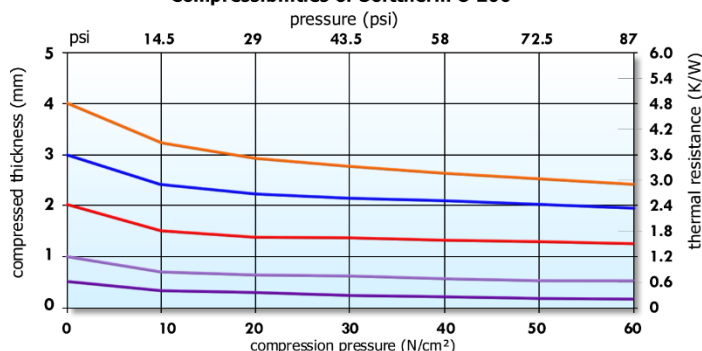
- RD-RAM Memory Module
- Heat Pipe Thermal Solutions
- Automotive Engine
- Control Units
- Plasma Supply Console

DISCLAIMER: Purchaser shall be solely responsible for determining the adequacy of the product for any and all uses which the purchaser shall apply the product, and the application of the product by the purchaser shall not be subject to any implied warranty of fitness for that purpose.

Properties	symbol	unit	U 200	U 281
Color			brown	gray
Thermal Properties				
Thermal Resistance	R_{th}	K/W	0.60	0.60
Thermal Impedance	R_{ti}	$^{\circ}\text{Cmm}^2/\text{W}$	240	240
		Kin^2/W	0.37	0.37
Thermal Conductivity	λ	W/mK	2.0	2.0
Electrical Properties				
Breakdown Voltage	$U_{d,ac}$	kV	7.0	7.0
Dielectric Breakdown	$E_{d,ac}$	kV/mm	14	14
Volume Resistivity		Ωm	5.1×10^9	5.32×10^9
Dielectric Loss Factor	$\tan\delta$	1	3.6×10^{-2}	7.8×10^{-2}
Dielectric Constant	ϵ_r	1	8.1	5.57
Mechanical Properties				
Measured Thickness ($\pm 10\%$)		mm	0.5*	0.5*
Hardness		Shore 00	55 – 70	55 – 65
Youngs Modulus**		N/cm ³	197	244
Physical Properties				
Density		g/cm ³	2.1	2.6
Application Temperature		$^{\circ}\text{C}$	-40 to +130	-40 to +130
TML		Ma.-%	< 0.8	< 0.9
Flame class		UL	94V-0	94V-0
Available Thicknesses		mm	0.5 – 4.0	0.5 – 3.0

**** Youngs modulus:** sample size 30mmx30mmx2.5mm; variable contact pressure; compression 50% of measured thickness

Compressibilities of Softtherm U 200



Compressibilities of Softtherm U 281

